

High Efficiency Recovery rectifiers

Major Ratings and Characteristics

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I _{F(AV)}	3.0A 50 V to 1000 V					
V_{RRM}						
I _{FSM}	100 A					
t _{rr}	50nS,75ns					
V _F	1.0V,1.3V,1.7V					
T _j max.	150 °C					

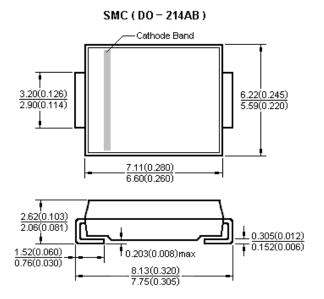


Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Ultrafast reverse recovery time
- Low switching losses, high efficiency
- High forward surge capability
- High temperatrue soldering:
 260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC

Mechanical Date

- Case: JEDEC DO-214AB molded plastic body over passivated chip
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Laser band denotes cathode end



Dimentsions in millimeters and (inchs)

Maximum Ratings & Thermal Characteristics & Electrical Characteristics

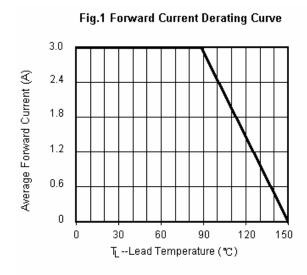
(T_A = 25 °C unless otherwise noted)

	Symbol	US3A	US3B	US3D	US3G	US3J	US3K	US3M	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	$I_{F(AV)}$	3							Α
Peak forward surge current 8.3 ms single half sinewave superimposed on rated load	I _{FSM}	100						Α	
Maximum instantaneous forward voltage at 3.0A	V_{F}		1.0		1.3		1.7		V
Maximum DC reverse current $T_A = 25 ^{\circ}\text{C}$ at Rated DC blocking voltage $T_A = 100 ^{\circ}\text{C}$	I _R	10.0 50						μΑ	
Maximum reverse recovery time at $I_F = 0.5 \text{ A}$, $I_R = 1.0 \text{ A}$, $I_{rr} = 0.25 \text{ A}$	t _{rr}	50 75						nS	
Typical junction capacitance at 4.0 V ,1MHz	CJ	15						pF	
Thermal resistance from junction to Lead	$R_{\theta JL}$	75						°C/W	
Operating junction and storage temperature range	T _J , T _{STG}	–55 to +150						°C	



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Characteristic Curves (T_A =25 $^{\circ}$ C unless otherwise noted)



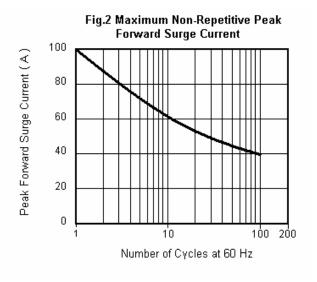


Fig.3 Typical Instantaneous Forward Characteristics

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